TE Internal #: 2339209-9

PCB Mount Header, Horizontal, Wire-to-Board, 9 Position, 1.27 mm

[.05 in] Centerline, Fully Shrouded, Tin, Surface Mount, Signal, Black

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Connectors > PCB Connectors > PCB Headers & Receptacles > PicoMQS, 2-10 POS HDR ASSY, Unsealed











Connector System: Wire-to-Board

Number of Positions: 9 Number of Rows: 1

Centerline (Pitch): 1.27 mm [.05 in] PCB Mount Orientation: Horizontal

All PicoMQS, 2-10 POS HDR ASSY, Unsealed (9)

Features

Product Type Features

Hybrid Header	No	
Connector System	Wire-to-Board	
Header Type	Fully Shrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		
Number of Positions	9	
Number of Rows	1	
PCB Mount Orientation	Horizontal	
Body Features		
Connector Code	A	

Black

Primary Product Color



Contact Features

Mating Tab Width	.5 mm
Mating Tab Thickness	.4 mm
Contact Mating Area Plating Material	Tin
Contact Type	Tab
Contact Current Rating (Max)	2 A

Termination Features

Termination Method to Printed Circuit Board	Surface Mount	

Mechanical Attachment

Connector Mounting Type	Board Mount
Mating Alignment	With

Housing Features

Usage Conditions

Operating Temperature Range	-40 - 130 °C[-40 - 266 °F]
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Operation/Application

Shielded	No
Circuit Application	Signal

Industry Standards

UL Flammability Rating	UL 94HB	

Packaging Features

Packaging Type	Tape & Reel
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Other

Interface Number	208-18038

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224)



Candidate List Declared Against: JUNE

2022 (224)

Does not contain REACH SVHC

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC

Free

Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought









Documents

Product Drawings
9POS,TAB0.5X0.4,HDR ASSY,90 DEG,COD A

English



CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2339209-9_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2339209-9_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2339209-9_A.3d_stp.zip

English

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Product Specifications

Product Specification

English

Product Specification

English